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(71) Applicant: **APPLIED MATERIALS, INC.** [US/US];  
3050 Bowers Avenue, Santa Clara, California 95054 (US).

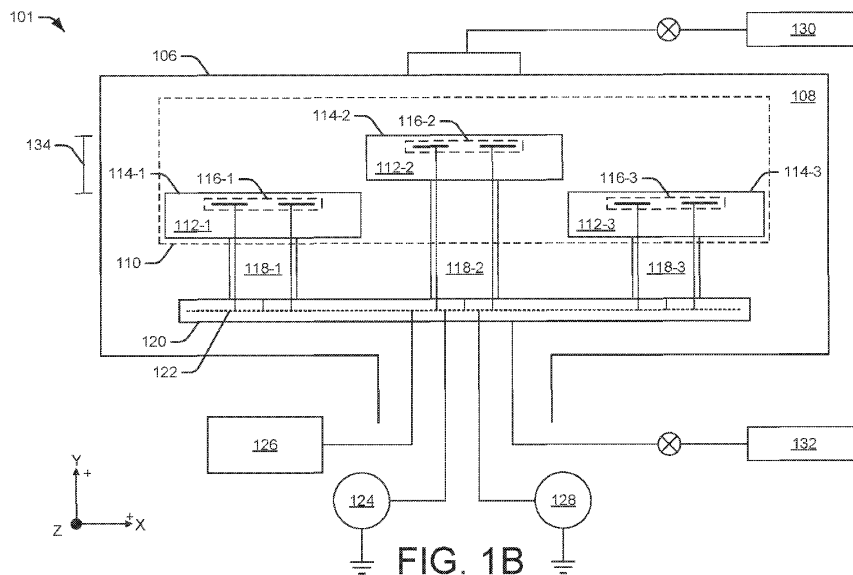
(72) Inventor: **PARKHE, Vijay D.**; c/o Applied Materials, Inc.,  
Law Dept., M/S 1269, 3050 Bowers Avenue, Santa Clara,  
California 95054 (US).

(74) Agent: **STEVENS, Joseph J.** et al.; Patterson + Sheridan  
LLP, 24 Greenway Plaza, Suite 1600, Houston, Texas 77046  
(US).

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(54) Title: ELECTROSTATIC CHUCK FOR NON-PLANAR SUBSTRATES



(57) Abstract: Embodiments of the disclosure include an electrostatic chuck (ESC). The ESC includes a substrate support including a first segment and a second segment that is laterally adjacent to the first segment. The first segment includes a first pair of electrodes. The second segment includes a second pair of electrodes. The first segment is to be displaced vertically relative to the second segment to accommodate a non-planar surface of a substrate.

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